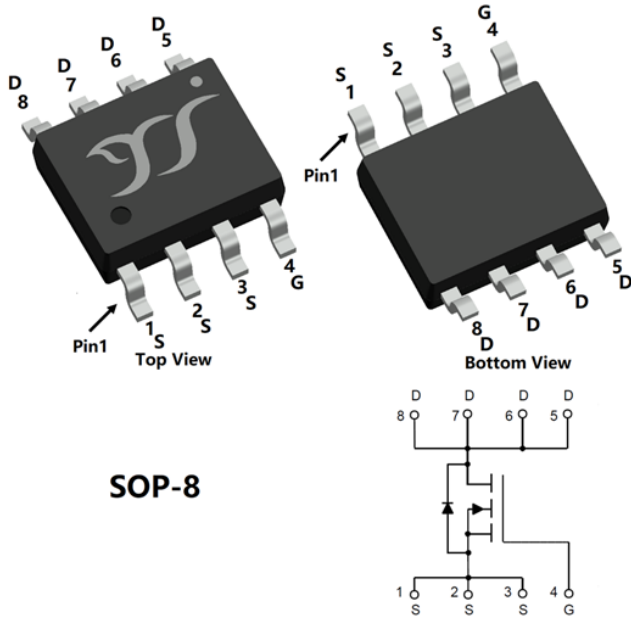


N-Channel Enhancement Mode Field Effect Transistor



SOP-8

Product Summary

- V_{DS} 100V
- I_D 11A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $< 13.5m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $< 17m\Omega$
- 100% EAS Tested

General Description

- Split gate trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power switching application
- Uninterruptible power supply
- DC-DC convertor

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | | Symbol | Limit | Unit |
|--|-------------------|----------------|----------|------------|
| Drain-source Voltage | | V_{DS} | 100 | V |
| Gate-source Voltage | | V_{GS} | ± 20 | V |
| Drain Current | $T_A=25^\circ C$ | I_D | 11 | A |
| | $T_A=100^\circ C$ | | 7 | |
| Pulsed Drain Current ^A | | I_{DM} | 90 | A |
| Avalanche energy ^B | | EAS | 121 | mJ |
| Total Power Dissipation ^C | $T_A=25^\circ C$ | P_D | 2.5 | W |
| | $T_A=100^\circ C$ | | 1 | |
| Junction and Storage Temperature Range | | T_J, T_{STG} | -55~+150 | $^\circ C$ |

■ Thermal resistance

| Parameter | | Symbol | Typ | Max | Units |
|---|--------------|-----------------|-----|-----|--------------|
| Thermal Resistance Junction-to-Ambient ^D | Steady-State | $R_{\theta JA}$ | 40 | 50 | $^\circ C/W$ |

■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| YJS11G10A | F2 | Q11G10A | 4000 | 8000 | 64000 | 7" reel |



YJS11G10A

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------------|---------------------|---|-----|------|------|-------|
| Static Parameter | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250μA | 100 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =100V, V _{GS} =0V | - | - | 1 | μA |
| | | V _{DS} =100V, V _{GS} =0V, T _J =150°C | - | - | 100 | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | - | - | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250μA | 1 | 1.7 | 3 | V |
| Static Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =10V, I _D =11A | - | 10.5 | 13.5 | mΩ |
| | | V _{GS} =4.5V, I _D =11A | - | 13 | 17 | |
| Diode Forward Voltage | V _{SD} | I _S =11A, V _{GS} =0V | - | - | 1.2 | V |
| Gate resistance | R _G | f=1MHz | - | 1.4 | - | Ω |
| Maximum Body-Diode Continuous Current | I _S | | - | - | 11 | A |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =50V, V _{GS} =0V, f=1MHz | - | 1800 | - | pF |
| Output Capacitance | C _{oss} | | - | 590 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 20 | - | |
| Switching Parameters | | | | | | |
| Total Gate Charge | Q _g | V _{GS} =10V, V _{DS} =50V, I _D =11A | - | 30 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 7.5 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 4.5 | - | |
| Reverse Recovery Charge | Q _{rr} | I _F =11A, di/dt=100A/us | - | 33 | - | nC |
| Reverse Recovery Time | t _{rr} | | - | 43 | - | ns |
| Turn-on Delay Time | t _{D(on)} | V _{GS} =10V, V _{DD} =50V, I _D =11A R _{GEN} =3Ω | - | 10 | - | ns |
| Turn-on Rise Time | t _r | | - | 33 | - | |
| Turn-off Delay Time | t _{D(off)} | | - | 28 | - | |
| Turn-off fall Time | t _f | | - | 9 | - | |

A. Repetitive rating; pulse width limited by max. junction temperature.

B. T_J=25°C, V_G=10V, R_G=25Ω, L=2mH, I_{AS}=11A.

C. P_q is based on max. junction temperature, using junction-case thermal resistance.

D. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in the still air environment with T_A=25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



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Typical Electrical and Thermal Characteristics Diagrams

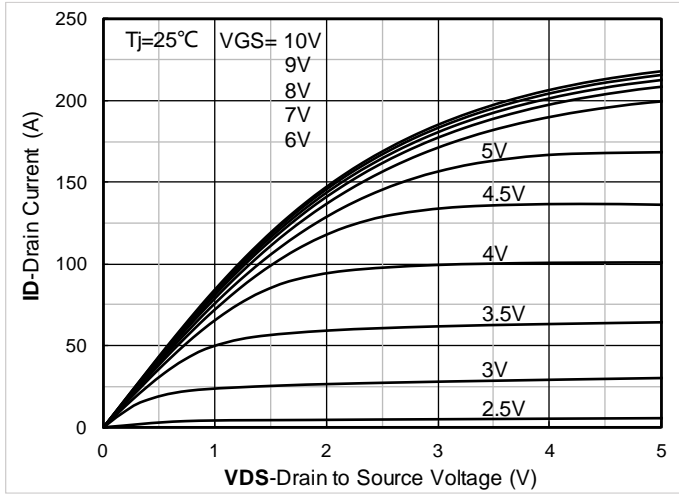


Figure 1. Output Characteristics

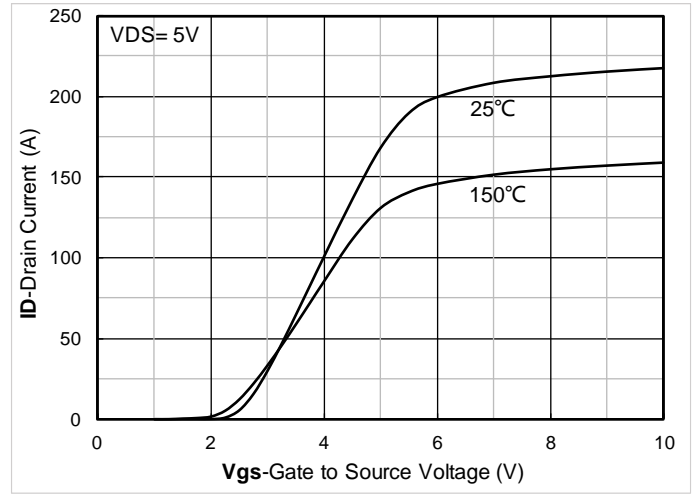


Figure 2. Transfer Characteristics

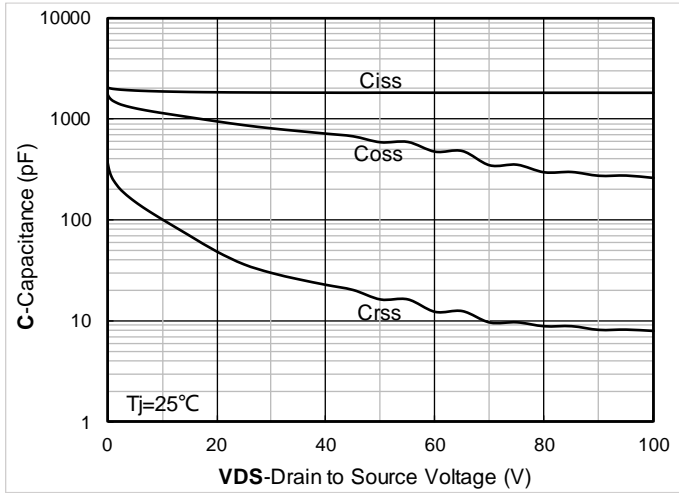


Figure 3. Capacitance Characteristics

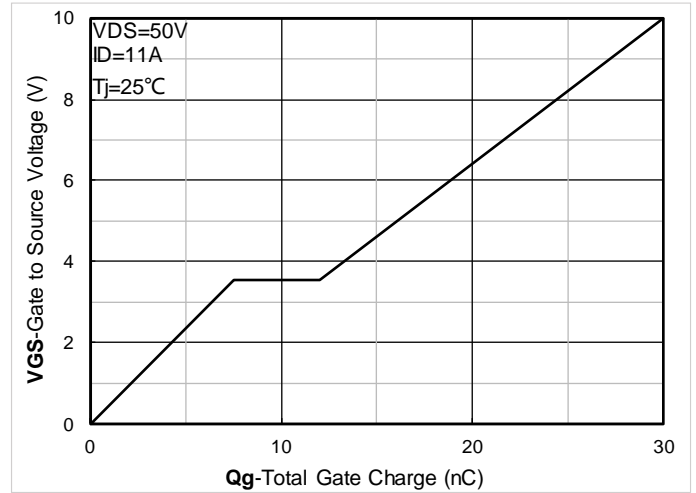


Figure 4. Gate Charge

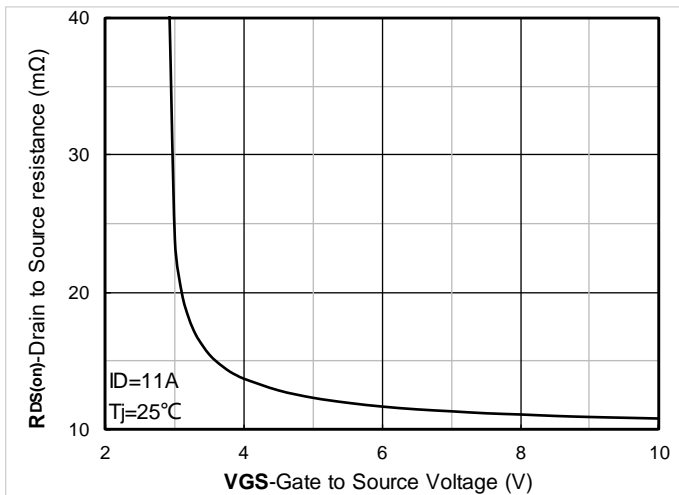


Figure 5. On-Resistance vs Gate to Source Voltage

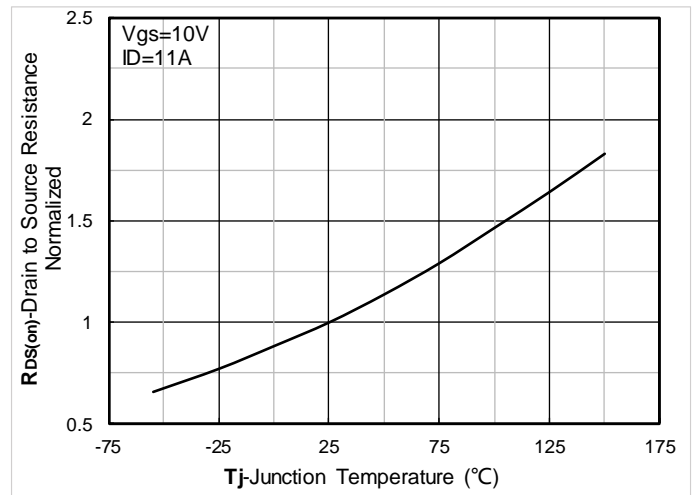


Figure 6. Normalized On-Resistance



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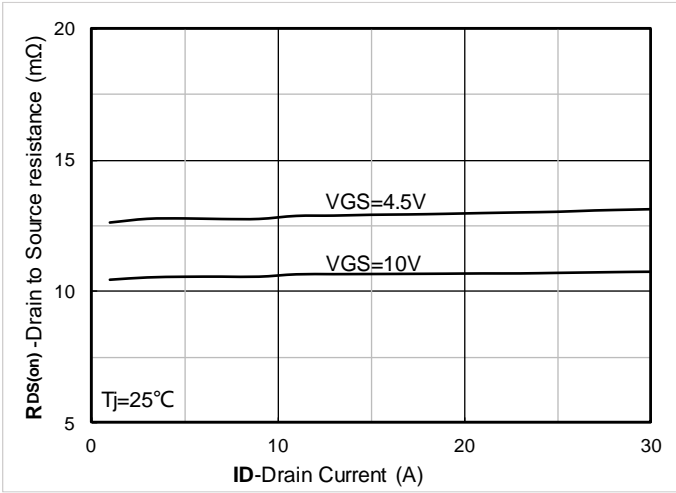


Figure 7. $R_{DS(on)}$ VS Drain Current

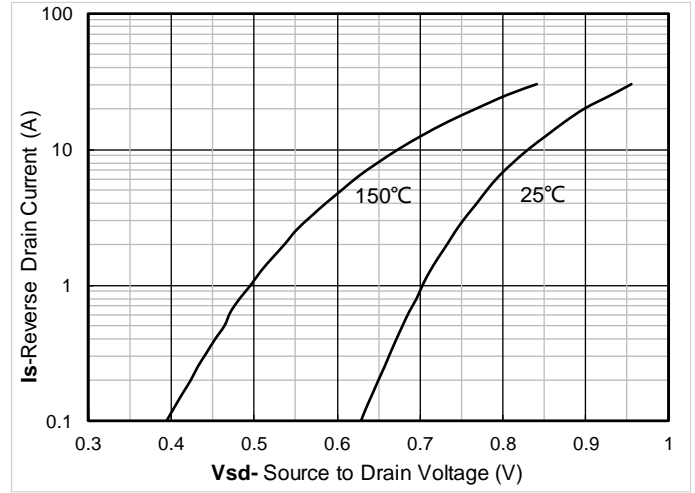


Figure 8. Forward characteristics of reverse diode

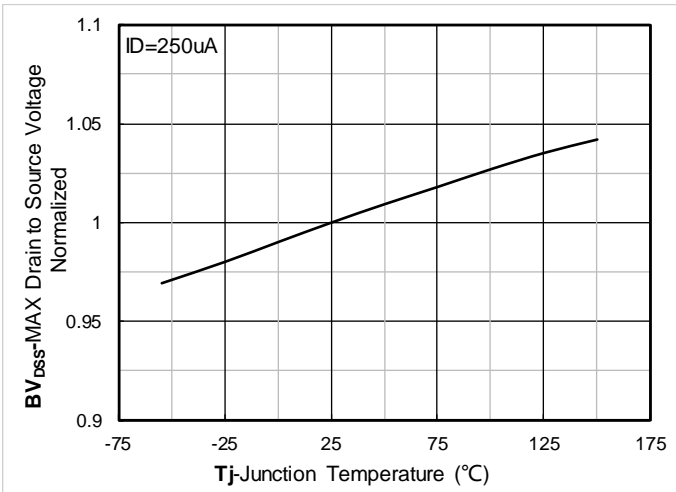


Figure 9. Normalized breakdown voltage

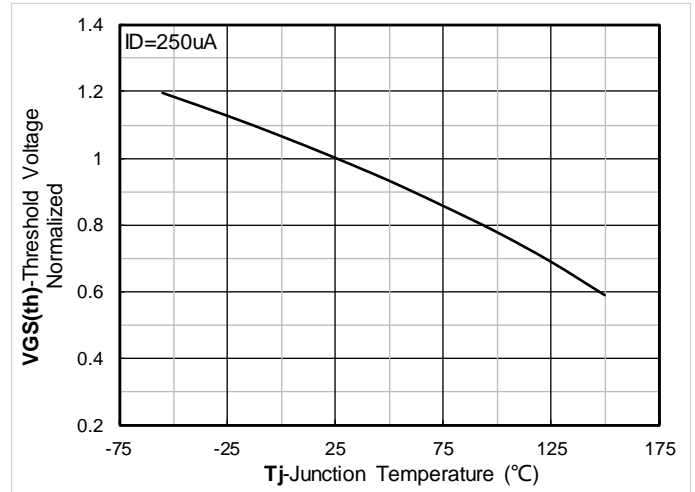


Figure 10. Normalized Threshold voltage

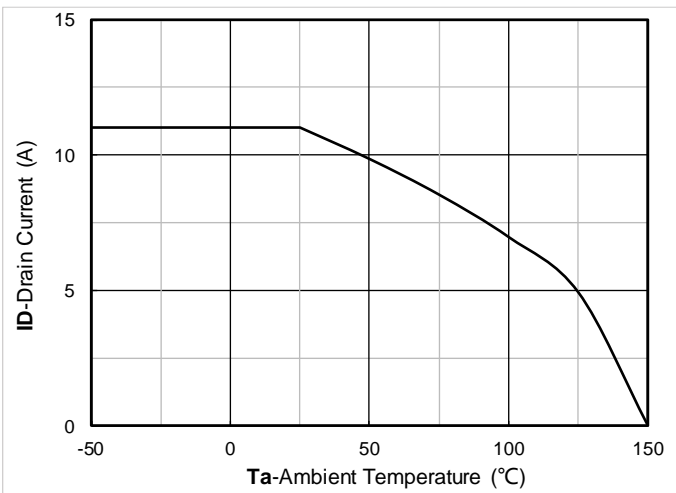


Figure 11. Current dissipation

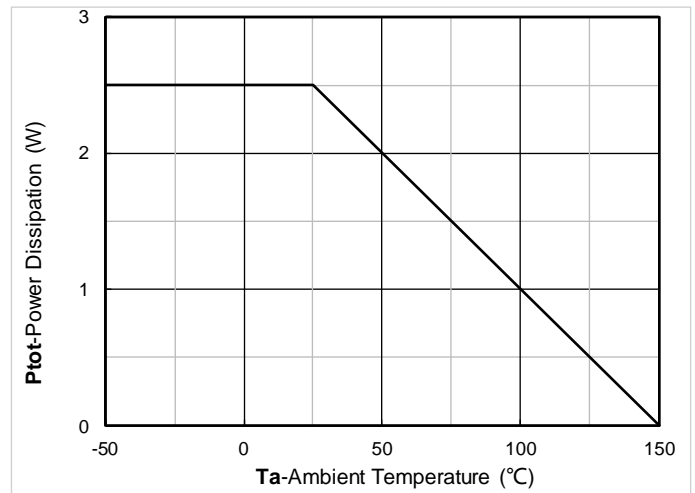


Figure 12. Power dissipation



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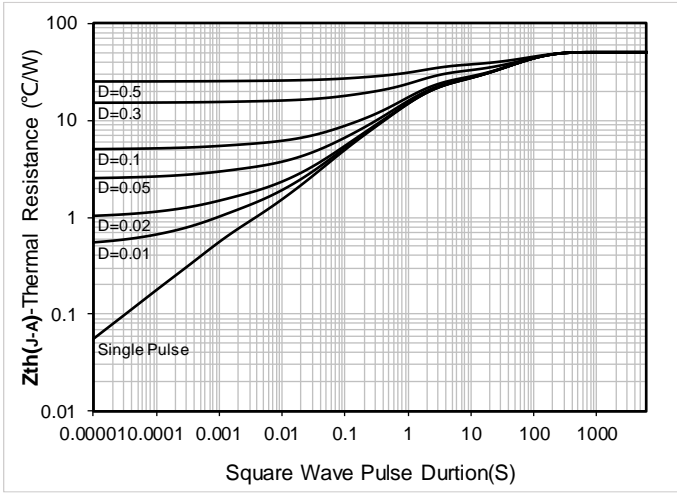


Figure 13. Maximum Transient Thermal Impedance

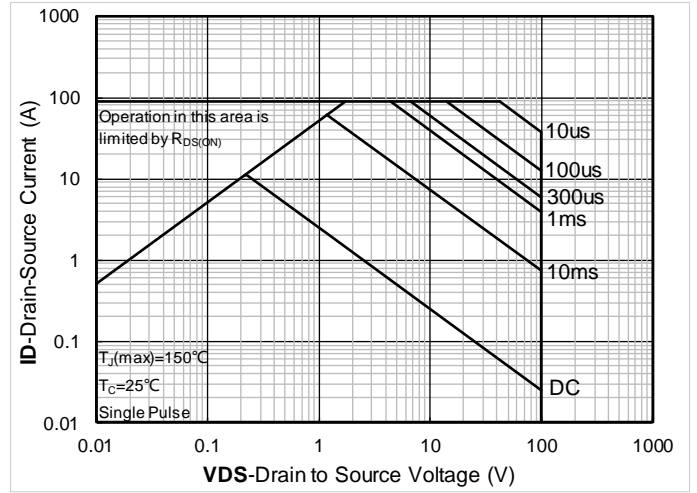
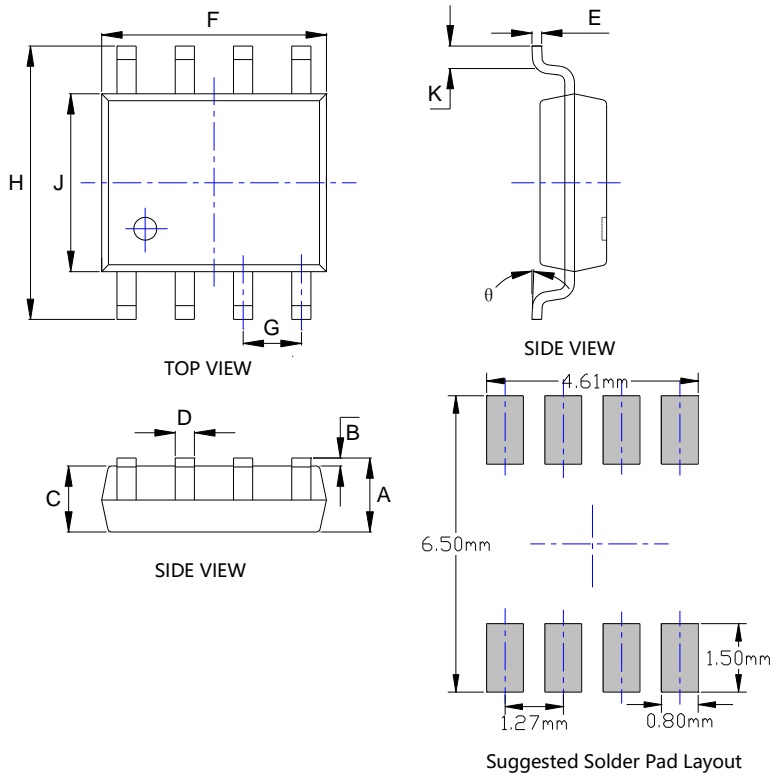


Figure 14. Safe Operation Area

■ SOP-8 Package information



| SYMBOL | DIMENSIONS | | | |
|----------|------------|-------|------------|-------|
| | INCHES | | Millimeter | |
| | MIN. | MAX. | MIN. | MAX. |
| A | 0.053 | 0.069 | 1.350 | 1.750 |
| B | 0.004 | 0.010 | 0.100 | 0.250 |
| C | 0.053 | 0.061 | 1.350 | 1.550 |
| D | 0.013 | 0.020 | 0.330 | 0.510 |
| E | 0.007 | 0.010 | 0.170 | 0.250 |
| F | 0.189 | 0.197 | 4.800 | 5.000 |
| G | 0.050BSC | | 1.270BSC | |
| H | 0.228 | 0.244 | 5.800 | 6.200 |
| J | 0.150 | 0.157 | 3.800 | 4.000 |
| K | 0.016 | 0.050 | 0.400 | 1.270 |
| θ | 0° | 8° | 0° | 8° |

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



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